NTC thermistors for temperature measurement

NTC Probes

Series/Type: M703/10k/A47
Ordering code: B57703M0103A047
Date: 2015-06-22
Version: 1
Application
High accuracy surface temperature measurement e.g. heatsink

Materials:

<table>
<thead>
<tr>
<th>No.</th>
<th>Item</th>
<th>Material</th>
<th>Property</th>
<th>Remarks</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>Thermistor</td>
<td>Ceramic</td>
<td>EPCOS NTC</td>
<td></td>
</tr>
<tr>
<td>2</td>
<td>Potting</td>
<td>Epoxy</td>
<td>Black</td>
<td></td>
</tr>
<tr>
<td>3</td>
<td>Ring Tongue</td>
<td>Brass with tinned plated</td>
<td></td>
<td></td>
</tr>
<tr>
<td>4</td>
<td>Shrinktube</td>
<td>Polyolefin</td>
<td>Black</td>
<td></td>
</tr>
<tr>
<td>5</td>
<td>Shrinktube</td>
<td>Polyolefin</td>
<td>Black</td>
<td></td>
</tr>
<tr>
<td>6</td>
<td>Wire</td>
<td>Stranded copper with silver plated, PTFE insulation</td>
<td>AWG 28 (19x0.07)</td>
<td>Blue</td>
</tr>
<tr>
<td>7</td>
<td>Crimp contact</td>
<td>Phosphor bronze with tin plated</td>
<td>JST SXH-002T-P0.6</td>
<td></td>
</tr>
<tr>
<td>8</td>
<td>Plug Housing</td>
<td>PA 6</td>
<td>JST XHP-2</td>
<td>Natural</td>
</tr>
</tbody>
</table>

JST connector is specified for a maximum temperature of 85°C

Ratings and characteristics

Climatic Category (IEC 60068-1) : 25/125/56
(test without voltage)

Lower category temperature

[°C] : -25

Upper category temperature

[°C] : 125 *

Rated resistance \( R_N \) // Tolerance

\[ R_N [\Omega \// \%] : 10000 \// \pm 3 \]

Rated temperature

\[ T_N [\degree C] : 25 \]

B-value : \( B_{(25/100)} \) // Tolerance

\[ B_N [K \// \%] : 3988 \// \pm 1 \]

R/T-Curve no. // \( R_{25} \)

\[ n [\// \Omega] : 8016 \// 10000 \]
Max. power rating at 25°C \( P_{25} \) [mW] : 150

Dissipation factor (in air) \( \delta_{th} \) [mW/K] : approx. 3 **
Thermal time constant (in air) \( \tau_a \) [s] : approx. 50 **
Heat capacity \( c_{th} \) [mJ/K] : approx. 150 **

Voltage proof // Time \( V_{is} \) [Vac] : 2700 // 1sec

Remark:
* Up to 150°C for max 30 minutes
** Typical values, depends on mounting situation

** Delivery mode **
Bulk

### NTC Resistance Temperature Curve

<table>
<thead>
<tr>
<th></th>
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<tbody>
<tr>
<td>-20</td>
<td>97070</td>
<td>91801</td>
<td>102339</td>
<td>5.4</td>
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<tr>
<td>-15</td>
<td>72929</td>
<td>69193</td>
<td>76665</td>
<td>5.1</td>
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<tr>
<td>-10</td>
<td>55330</td>
<td>52658</td>
<td>58002</td>
<td>4.8</td>
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<tr>
<td>-5</td>
<td>42315</td>
<td>40391</td>
<td>44239</td>
<td>4.5</td>
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<tr>
<td>0</td>
<td>32650</td>
<td>31254</td>
<td>34046</td>
<td>4.3</td>
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<tr>
<td>5</td>
<td>25388</td>
<td>24369</td>
<td>26406</td>
<td>4.0</td>
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<tr>
<td>10</td>
<td>19900</td>
<td>19152</td>
<td>20648</td>
<td>3.8</td>
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<tr>
<td>15</td>
<td>15708</td>
<td>15156</td>
<td>16260</td>
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<tr>
<td>20</td>
<td>12490</td>
<td>12081</td>
<td>12899</td>
<td>3.3</td>
</tr>
<tr>
<td>25</td>
<td>10000</td>
<td>9700</td>
<td>10300</td>
<td>3.0</td>
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<td>30</td>
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<td>35</td>
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<td>6759</td>
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<td>40</td>
<td>5327</td>
<td>5130</td>
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<td>45</td>
<td>4369</td>
<td>4199</td>
<td>4539</td>
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<td>50</td>
<td>3603</td>
<td>3456</td>
<td>3750</td>
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<td>55</td>
<td>2986</td>
<td>2859</td>
<td>3114</td>
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<td>60</td>
<td>2488</td>
<td>2377</td>
<td>2599</td>
<td>4.5</td>
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<tr>
<td>65</td>
<td>2083</td>
<td>1987</td>
<td>2180</td>
<td>4.6</td>
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</tbody>
</table>
### Reliability Data

<table>
<thead>
<tr>
<th>Test</th>
<th>Test conditions</th>
<th>$\Delta R_{25}/R_{25}$ (typical)</th>
<th>Remarks</th>
</tr>
</thead>
<tbody>
<tr>
<td>Storage in dry Heat</td>
<td>Storage at upper category temperature Temperature: 125°C; Duration: 1000 h</td>
<td>&lt; 3 %</td>
<td>No visible damage</td>
</tr>
<tr>
<td>Storage in coldness</td>
<td>Storage at upper category temperature Temperature: -20°C; Duration: 1000 h</td>
<td>&lt; 3 %</td>
<td>No visible damage</td>
</tr>
</tbody>
</table>
| Storage in damp, heat, steady state | Temperature of air: 40°C  
Relative humidity: 93 %  
Duration: 56 days     | < 3 %                            | No visible damage              |
| Rapid temperature cycling        | Lower test temperature: -20 °C  
Upper test temperature: +125 °C  
Number of cycles : 100  
Medium: Air  
Dwell time: 10 minutes with travel time 30 s | < 3 %                            | No visible damage            |
Cautions and warnings

Storage

- Store thermistors only in original packaging. Do not open the package prior to storage.
- Storage conditions in original packaging: storage temperature –25 °C ... +45 °C, relative humidity ≤75% annual mean, <95% maximum 30 days per annum, dew precipitation is inadmissible.
- Do not store thermistors where they are exposed to heat or direct sunlight. Otherwise, the packing material may be deformed or components may stick together, causing problems during mounting.
- Avoid contamination of thermistor surface during storage, handling and processing.
- Avoid storage of thermistors in harmful environments like corrosive gases (SOx, Cl etc).
- Use the components as soon as possible after opening the factory seals, i.e. the polyvinyl-sealed packages.
- Solder thermistors within the time specified after shipment from EPCOS. For leaded components this is 24 months.

Handling

- NTC thermistors must not be dropped. Chip-offs or any other damage must not be caused during handling of NTCs.
- Do not touch components with bare hands. Gloves are recommended.
- Avoid contamination of thermistor surface during handling.
- Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.

Bending/ twisting leads

- A lead (wire) may be bent at a minimum distance of twice the wire’s diameter plus 4 mm from the component head or housing. When bending ensure the wire is mechanically relieved at the component head or housing. The bending radius should be at least 0.75 mm.

Soldering

- Use resin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.
Mounting

- Ensure that no thermo-mechanical stress occurs due to production processes (curing or overmolding processes) when thermistors are sealed, potted or overmolded or during their subsequent operation. The maximum temperature of the thermistor must not be exceeded. Ensure that the materials used (sealing/potting compound and plastic material) are chemically neutral.
- Electrodes/contacts must not be scratched or damaged before/during/after the mounting process.
- Contacts and housing used for assembly with the thermistor must be clean before mounting.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of the thermistor. Be sure that surrounding parts and materials can withstand the temperature.
- Avoid contamination of the thermistor surface during processing.
- The connections of sensors (e.g. cable end, wire end, plug terminal) may only be exposed to an environment with normal atmospheric conditions.
- Tensile forces on cables or leads must be avoided during mounting and operation.
- Bending or twisting of cables or leads directly on the thermistor body is not permissible.
- Avoid using chemical substances as mounting aids. It must be ensured that no water or other liquids enter the NTC thermistors (e.g. through plug terminals). In particular, water-based substances (e.g. soap suds) must not be used as mounting aids for sensors.

Operation

- Use thermistors only within the specified operating temperature range.
- Use thermistors only within the specified power range.
- Environmental conditions must not harm the thermistors. Only use the thermistors under normal atmospheric conditions or within the specified conditions.
- Ensure that no significant thermo-mechanical stress occurs during operation due to the mounting situation. Fixtures must not overstress the sensor by an excessive mechanical preload.
- Contact of NTC thermistors with any liquids and solvents shall be prevented. It must be ensured that no water enters the NTC thermistors (e.g. through plug terminals). For measurement purposes (checking the specified resistance vs. temperature), the component must not be immersed in water but in suitable liquids (e.g. Galden).
- Avoid dewing and condensation unless thermistor is specified for these conditions.
- Bending or twisting of cables and/or wires is not permissible during operation of the sensor in the application.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by malfunction.

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